

Solder paste WINDOT S-005-NP303 T5

Product description

GENMA SMD solder paste – our jet dispenser solder paste WINDOT shows an excellent performance. Uniform dots as small as 220µm are possible in a continuous process at high speed. The result are attractive soldering joints that are surrounded by clear flux residues. Nitrogen reflow is recommended. Cleaning after soldering is not necessary.

Technical properties

	Specific value	Testing method
Alloy	Sn 96,5 / Ag 3,0 / Cu 0,5 / SAC305	
Melting temperature range	217 - 221	IEC61189-11

Compliance

Conform with RoHS-Regulation 2011/65/EU and 2015/863/EU

Contains no substances more than threshold (0,1%) according to REACH legislation EG Nr. 1907/2006 (SVHC-list - dated 26.02.2024)